

Japan - Korea International Symposium on Die and Mold  
日韓国際金型シンポジウム  
「次世代に向けての金型産業と金型技術」

日 時：平成27年3月13日（金）	12:00～13:00 Lunch
会 場：韓国 KINTEX	13:30～15:30 Proposal on the Innovative Break- Through in Die and Mold
主 催：日本塑性加工学会金型分科会，韓国金型工学会	15:30～15:50 Coffee Break
共 催：日本金型工業会、韓国金型工業組合	15:50～16:30 Discussion
趣 旨：本シンポジウムは次世代に向けた最新の金型技術 を中心に，日本と韓国の相互の研究開発成果を報 告し，課題や方向性についての意見交換・情報交 換ならびに国際交流を目的とするものです．本学 会の活性化基金を一部利用して開催されます．	16:30～16:50 Concluding Remarks
内 容： 9:30～ 9:50 Opening Remarks	参加費：KINTEX 入場料のみ
9:50～10:30 Policy and economic perspective	問合先：〒400-8511 山梨県甲府市武田4-3-11 山梨大学 工学部 機械工学科 吉原 正一郎 宛
10:30～11:50 Private company strategy in Die and Mold	電話：055-220-8438 FAX：055-220-8779 E-mail：yoshihara@yamanashi.ac.jp

# Japan - Korea International Symposium on Die and Mold

Date: Friday, March 13<sup>th</sup>, 2015

Location: Kintex, Korea

Moderator: Prof. Si Tae Won

Dr. Gil Sang Yun

(All presentations will be translated by simultaneous interpreter.)

Time	Contents	KOREA	JAPAN
9:30-9:50	Opening Remarks	Mr. Park Sun Hwang (Chairman of KODMIC)	Em. PhD. Katsuhiro Ueda (Emeritus Chairman of JDMA)
9:50-10:30	Policy and economic perspective	Supportive policies for Die and Mold industry in Korea by Dr. Kim Jung Han (Chairman of Korea National Ppuri Industry Promotion Center)	Macro-economic perspectives in East Asia by Prof. Toshiyuki Baba (University of Hossei)
10:30-11:50	Private company strategy in Die and Mold	Pending 1. (Recommended by KODMIC)	Dr. Komatsu (JSTP; Executive of Komatsu Precision, Co. Ltd.)
		Pending 2. (Recommended by KODMIC)	Mr. Kida (President, Showa Precision, Co. Ltd.)
12:00-13:00	Lunch		
13:30-15:30	Proposal on the Innovative Break-Through in Die and Mold	Prof. Hwang Ji Hong (Seoul National University of Science and Technology)	Prof. T. Aizawa (JSTP; Shibaura Institute of Technology, Academic Coordinator, Japan Die and Mold Association)
		Dr. Young Moo Heo (KSDME; Korea Institute of Industrial Technology)	Prof. Yoshihara (Japan Society of Light Metals; Yamanashi University)
		Dr. Jong Deok Kim (KSTP; Korea Institute of Industrial Technology)	Dr. Tamaoki (Tokyo Metropolitan Industrial Technology Research Institute)
15:30-15:50	Coffee Break		
15:50-16:30	Discussion	Mr. Park Sun Hwang (Chairman of KODMIC)	Em. PhD. Katsuhiro Ueda (Emeritus Chairman of JDMA)
16:30-16:50	Concluding Remarks	Prof. Si Tae Won (KSDME, KSTP; Seoul National University of Science and Technology)	Prof. T. Aizawa (JSTP; Shibaura Institute of Technology, Academic Coordinator, Japan Die and Mold Association)